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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE  
(Case No. 207.008-US)

In the Application of: **Lutz et al.**) Group  
Serial No: **10/627,237**) Art Unit: **2812**  
Filed: **July 25, 2003**) Before  
Title: **Anchors for Microelectromechanical Systems**)  
**Having an SOI Substrate, and Method for**)  
**Fabricating Same**)

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Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on June 10, 2004

Michiko Sato  
(person signing this certificate)  
Michiko Sato  
Signature

#### FIFTH INFORMATION DISCLOSURE STATEMENT

Dear Sir:

Submitted herewith is one (1) sheet of a modified Form PTO-1449. A copy of each document cited on the attached Form PTO-1449 is also submitted.

It is respectfully requested that the Examiner make his/her consideration of these documents formally of record with the initial Office Action.

Respectfully submitted,



Neil A. Steinberg  
Reg. No. 34,735  
650-968-8079

Date: June 10, 2004



Sheet 1 of 1

<b>PTO-1449 (Modified)</b> <b>U.S. DEPARTMENT OF COMMERCE</b> <b>PATENT AND TRADEMARK OFFICE</b>  <b>INFORMATION DISCLOSURE STATEMENT</b> <b>BY APPLICANT</b>	<b>ATTY. DOCKET NO.</b> <b>207.008-US</b>	<b>SERIAL NUMBER</b> <b>10/627,237</b>
	<b>APPLICANT(S)</b> <b>Lutz et al.</b>	
	<b>FILING DATE</b> <b>July 25, 2003</b>	<b>GROUP ART UNIT</b> <b>2812</b>

## **U.S. PATENT DOCUMENTS**

## **FOREIGN PATENT DOCUMENTS**

EXAMINER INITIALS	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION YES/NO

**OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)**


<b>EXAMINER</b>	<b>DATE CONSIDERED</b>
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**EXAMINER:** Initial citation if reference was considered. Draw line through citation if not in conformance to MPEP 609 and not considered. Include copy of this form with next communication to applicant.